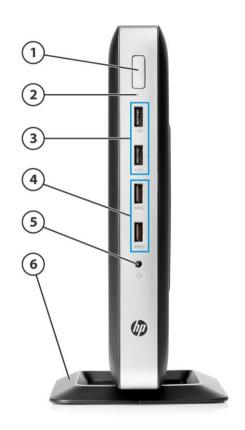
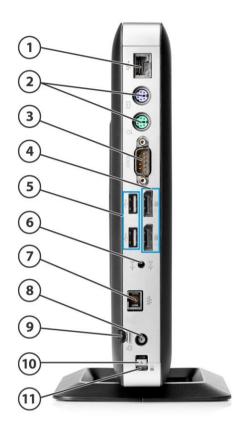
Overview

HP t630 Thin Client





FRONT

- 1. Power button (with integrated power indicator)
- 2. Flash memory activity indicator
- 3. (2) Hi-Speed USB 2.0 ports
- 4. (2) SuperSpeed USB 3.0 ports
- 5. 3.5 mm headset port
- 6. System stand

INTERNAL

(1) SuperSpeed USB 3.0 port secured inside chassis

BACK

- 1. RJ45 network interface connector
- 2. PS/2 ports for keyboard and mouse
- 3. Serial port
- 4. (2) DisplayPort™ 1.2 video outputs
- 5. (2) Hi-Speed USB 2.0 ports
- 6. 3.5 mm audio line-out/line-in port
- 7. Optional I/O Port (can be configured as: VGA output, 2nd
- ' serial port, external antenna or Fiber NIC interface)
- 8. +19V DC power input
- 9. Retractable power cord retention hook
- 10. Rear I/O cover removal latch
- 11. Cable lock slot

Overview

AT A GLANCE

- AMD GX-420GI SOC; 2.0 2.2 GHz quad-core with a Radeon R6E based graphics core
- DDR4 dual-channel SDRAM system memory; up to 1,866 MT/s transfer rate; two SODIMM slots; up to 32 GB supported¹
- (2) DisplayPort™ 1.2 video outputs supporting up to Ultra High Definition (UHD)/4K (3840 x 2160) resolutions
- Solid-state flash memory storage; M.2 form factor modules; support for up to 2 modules for maximum local storage capacity and data management
- Active thermal management technology monitors component operating temperatures, throttles SOC operation if appropriate, and prevents unit thermal shutdown
- Gigabit Ethernet (GbE) network connection supported via an integrated Realtek GbE NIC module
- Optional Allied Telesis Fiber Optic NICs; Fast Ethernet (100 Mb/s) or Gigabit (1,000 Mb/s)
- Optional Wi-Fi/Bluetooth® adapters including antennas integrated internally in the chassis

NOTE: Fiber optic and Wi-Fi NIC options cannot be supported together²

- (2) SuperSpeed USB 3.0 and (2) Hi-Speed USB 2.0 on front, (2) Hi-Speed USB 2.0 on rear and (1) SuperSpeed USB 3.0 inside
 the chassis.
- Legacy ports include PS/2 keyboard and mouse, up to (2) serial ports and up to (1) VGA video output
- Integrated PC speaker for basic audio playback; 3.5 mm headset audio port on front and 3.5 mm audio port on rear that can be configured as line in or line out supporting headphones, external speaker systems, or microphone
- TCG certified Trusted Platform Module (TPM) chipset; version 1.2 with HP ThinPro/Smart Zero Core and Windows Embedded Standard 7E models, version 2.0 with Windows 10 IoT Enterprise models; other security features include a system BIOS designed to address NIST SP 800-147 guidelines, cable lock slot, and power cord retention clip to prevent accidental disconnects: (1) internal SuperSpeed USB 3.0 port for securing USB flash drives inside the chassis
- ENERGY STAR® certified and EPEAT® Gold registered in the United States (except for some models configured with Fiber
 Optic NIC networking options). See http://www.epeat.net for registration status in other countries
- Post-consumer recycled plastics content greater than 25% total unit plastics (by weight)
- Low halogen³ material content
- All models TAA compliant (in North America & EMEA); TAA models available in APJ by request

Warranty

HP Customer Support: limited three-year hardware limited warranty in most regions; HP Care Packs are extended service contracts that go beyond your standard limited warranties; for more details visit http://www.hp.com/go/cpc

¹ If configured with a Windows Embedded 32-bit operating system, memory above 3.2 GB may not be available due to operating system limitations

² Wireless access point and Internet access is required; availability of public wireless access points is limited

³ This product is low halogen except for power cords, cables and peripherals, as well as the optional Fiber Optic NIC module; service parts obtained aftermarket may not be low halogen

OPERATING SYSTEMS

HP Smart Zero Core HP ThinPro Windows Embedded Standard 7E Windows 10 IoT Enterprise

PROCESSOR

Model	CPU Frequency Max/Base	Cores	GPU CUs	TDP	L2 Cache	GPU	Memory
AMD GX-420GI	2.2/2.0 GHz	4	6	16.1 W	2 MB	626 MHz	DDR4

GRAPHICS

Number of displays supported: 2

Video outputs: (2) DisplayPort™ 1.2 (standard)

(1) VGA (optional)

NOTE: adding the optional VGA output does not increase the number of displays supported.

Maximum screen resolution: Supports 2 displays at 3840 x 2160 @ 60 Hz via the standard DisplayPort™ outputs

Supports 1 display at 1920 x 1200 @ 60 Hz via the optional VGA output

NOTES:

 The system should be configured with dual channel memory (two SODIMMs) for optimal display resolution performance

 Dual channel memory (two SODIMMs) is required to achieve maximum resolution on dual UHD displays

MEMORY

Type: DDR4 dual channel SDRAM

Data Transfer Rate: Up to 1,866 MT/s

Peak Transfer Rate:14,933 MB/sNumber of Slots2 x SODIMM

4, 8, 16 and 32 GB

Capacities:

NOTE: WES 7E is a 32-bit operating system and only recognizes up to 3.2GB RAM

Reserved for Graphics: 256 MB, 512 MB (default) or 1 GB

NOTE: The system's Graphics Processing Unit (GPU) uses part of the total system memory. System memory dedicated to graphics performance is not available for use by other programs

BIOS

UEFI Specification Revision 2.3.1

Meets requirements for Common Criteria, an independent third-party certification of

trustworthiness

Meets requirements for FIPS 140-2, a standard for cryptographic integrity

Trusted Platform Module (TPM)

TPM 1.2 HP ThinPro/Smart Zero Core and Windows Embedded Standard 7E models

TPM 2.0 Windows 10 IoT Enterprise and No OS models

Security features
Other BIOS details

System BIOS designed to address NIST SP 800-147 guidelines

See t630 Thin Client Troubleshooting Guide

STORAGE

Capacities:

Type: NAND flash memory; non-volatile

Number of Sockets: (2) M.2 designated as primary and secondary

Primary storage options:

No OS, Smart Zero & ThinPro = 8, 16, 32, 64 and 128 GB

WES 7E-32bit = 16, 32, 64 and 128 GB
 Win 10 IoT-64 bit = 32, 64 and 128 GB

NOTE: The primary socket supports M.2 flash up to size 2280 modules; the secondary socket accommodates up to size 2242 modules. The highest capacity offered in the secondary slot is 64 GB.

Secondary storage options:

All configurations = 8, 16, 32 & 64 GB

• WES 7E-32bit restrictions for factory = The secondary drive must be equal to or greater than the capacity of the primary drive.

NOTE: Secondary SSD capacity restrictions are for factory only. Therefore, customer may change secondary storage to any capacity desired after received from factory.

Solid-state flash-based memory modules are the primary operating system storage media for thin clients supporting highly virtualized operating environments. Thin clients display a hosted session from a data center through standard IP networks which minimizes the required size of local flash-based storage. In a traditional thin client environment, data and application files are stored securely in the remote data center and not on the local storage device.

The HP t630 Thin Client uses three types of flash memory: MLC (2-bits per cell), Ultra MLC (2-bits per cell, but only 1 is utilized) and TLC (3-bits per cell). Because the classic thin client use cases seldom require writing to flash memory storage, a relatively low capacity MLC flash memory module is typically used to provide the best cost and performance. However, when the use case calls for writing to the local flash memory storage module careful consideration should be given to the selection of the proper storage module. A larger capacity and/or the use of Ultra MLC technology could be required to adequately support the usage being planned or expected from the thin client.

Flash Memory Specification	MLC (Multi-level Cell)	UMLC (Ultra MLC)	TLC (Triple-level Cell)
Bits per cell	2	2 (only 1 is used)	3
Terabytes Written (TBW) *	5 TBW* – 8GB 10 TBW* – 16GB 20 TBW* – 32GB	50 TBW* – 16GB 100 TBW* – 32GB	70 TBW* - 128GB

* Terabytes Written (TBW) calculated based on JESD-219 SSD Client workload

Input/Output

(2) Hi-Speed USB 2.0 (front access)

USB Interfaces:(2) Hi-Speed USB 2.0 (rear access)
(2) SuperSpeed USB 3.0 (front access)

(1) SuperSpeed USB 3.0 (inside chassis)

(2) DisplayPort™ 1.2 digital outputs (standard)

Video Outputs: (1) VGA analog output (optional)

NOTE: the optional VGA output does not increase the number of displays supported.

(2) PS/2 keyboard/mouse ports

1/0 Interfaces: (1) RJ45 network interface connector

(1) Serial port (standard): can be configured to produce 5V of power

(1) 2nd Serial port (optional)

(1) 3.5 mm headset port (front)

(1) 3.5 mm audio combo line-out/line-in port (rear)

NOTE: a single position at the back of the system is utilized for one of four optional outputs. One of the

following can be configured to any system:

Optional VGA video output

Optional 2nd serial port

• Optional Fiber Optic NIC interface

• Optional external Wi-Fi antenna

AUDIO/VIDEO

Audio CODECs

Video CODECs

Audio

• Internal amplified speaker system for basic audio playback

Audio Subsystem • 3.5 mm headset socket (front access)

• 3.5 mm combo line-out/ line-in socket (rear access)

MP3

AAC Stereo

HE AAC

Includes hardware acceleration support

MPEG-4 part 2 (DivX, Xvid)

MPEG-4 part 10 (H.264, AVC)

WMV 7/8/9 VC-1 & ASF Demuxer

Includes hardware acceleration support

HARDWARE SECURITY

- Security lock slot (cable lock sold separately)
- Power cord retention clip
- Internal SuperSpeed USB 3.0 port
- Trusted Platform Module (version 1.2 or 2.0 depending upon the model's configured operating system)



NETWORKING

• Realtek Gigabit Ethernet

Wake on LAN (WOL)

Hardware Networking:

PXE

TCP/IP with DNS and DHCP

Secure Socket Tunneling Protocol (SSTP); supported with Windows OS

Intel® Dual Band Wireless-AC 3168 Wi-Fi/Bluetooth® combo adapter

Wi-Fi Networking*

•

• Intel® Dual Band Wireless-AC 8260 Wi-Fi/Bluetooth® combo adapter

FIBER OPTIC NETWORKING

Adapter Option: Allied Telesis AT-27M2/SC Fiber Fast Ethernet Network Interface

Form Factor: M.2

Connector: SC; compliant with IEC 61754-4

IEEE 802.1p priority encoding/tagging (QoS, CoS)

IEEE 802.1q VLAN tagging
 IEEE 802.3x flow control

Buffer/FIFO: 2K transmit and 2K receive

Features: • Loopback mode

Descriptor-Based Buffer Management

Wake-on-LAN from S3 (Sleep) and S4 (Hibernate) not supported

 Link Detection and PHY interface power; the PHY interface, Link detection and Link LED should be enabled by default at power-up

>= 85 Mbit/s receive, <= 30% CPU utilization >= 85 Mbit/s transmit, <= 30% CPU utilization

• >= 170 Mbit/s total bi-directional. <= 30% C:U utilization

The minimum transfer size at 100 Mbit/s is 1 Gbps

External Interface: Complies with IEEE 802.3 1000BASE-X operation

• Uses less than 1775 mW of power at full performance

Supports all PCI Express bus states L0, L0s, L1 and L2

The MAC address is unique for each system; assigned from the board assembly manufacturer's

IEEE registered allocation.

Non-volatile Storage:

The PCI subsystem ID is unique to HP and unique to each design to allow Windows Update to

be finely controlled.



Performance:

Power:

^{*}Wireless access point and internet access required. Availability of public wireless access points limited.

Adapter Option: Allied Telesis AT-29M2/SC or AT-29M2/LC Fiber Gigabit Network Interface

Form Factor: M.2

Performance:

Connector: SC; compliant with IEC 61754-4

Features: • IEEE 802.1p priority encoding/tagging (QoS, CoS)

IEEE 802.1Q VLAN tagging
 IEEE 802.3x flow control

• Buffer/FIFO: 22K transmit and 40K receive

Loopback mode

Descriptor-Based Buffer Management

Wake-on-LAN from S3 (Sleep) and S4 (Hibernate) not supported

Link Detection and PHY interface power; the PHY interface, Link detection and Link LED

should be enabled by default at power-up

>= 800 Mbit/s receive, <= 30% CPU utilization
>= 800 Mbit/s transmit, <= 30% CPU utilization

• >= 1500 Mbit/s total bi-directional, <= 30% C:U utilization

The minimum transfer size at 1000 Mbit/s is 1500 Gbps

External Interface: Complies with IEEE 802.3 1000BASE-X operation

Power:

• Uses less than 2100 mW of power at full performance

Supports all PCI Express bus states L0, L0s, L1 and L2

Non-volatile Storage: The MAC address is unique for each system; assigned from the board assembly

manufacturer's IEEE registered allocation.

The PCI subsystem ID is unique to HP and unique to each design to allow Windows Update to

be finely controlled.



QuickSpecs

Technical Specifications

SOFTWARE SUPPORT

		НР	Microsoft Wind	lows Embedded
Host Environment	Protocol	ThinPro Smart Zero Core	WES 7E	WIN 10 IoT
Microsoft Remote Desktop Services	Remote FX (RFX), RDP	√	√	√
Citrix®	ICA, HDX	√	√	√
VMware® Horizon	RDP, PCoIP	√	√	√

	НР	Microsoft Windows Embedded		
Protocol Clients	ThinPro Smart Zero Core	WES 7E	WIN10 IoT	
Citrix® Receiver	√	√	√	
Microsoft Remote Desktop Client	N/A	√	√	
VMware™ Horizon View™ Client	√	√	√	
HP Remote Graphics Software (RGS)	via add-on	√	√	
HP TeemTalk Terminal Emulator	√	via add-on	via add-on	
Free RDP	√	N/A	N/A	

	НР	Microsoft Windows Embedded		
Browser Support	ThinPro Smart Zero Core	WES 7E	WIN10 IoT	
Mozilla Firefox	36	N/A	N/A	
Internet Explorer	N/A	11	11	

	HP	Microsoft Windows Embedded		
Security	ThinPro Smart Zero Core	WES 7E	WIN10 IoT	
Smart Card	√	√	√	
Log-on Manager	√	√	√	
Read only Operating System	√	√	√	
802.1x	√	√	√	
Operating System Write Filter	N/A	EWF, FBWF	UWF	
Microsoft Firewall	N/A	√	√	



QuickSpecs

Technical Specifications

	НР	Microsoft Windows Embedded		
Management Tools	ThinPro Smart Zero Core	WES 7E	WIN10 IoT	
HP Device Manager	√	√	√	
HP ThinUpdate	N/A	√	√	
HP Easy Tools	√	via add-on	N/A	
HP Smart Zero Client Services	√	N/A	N/A	
Microsoft SCCM/EDM agent	N/A	√	√	

	НР	Microsoft Wine	lows Embedded
Additional Components	ThinPro Smart Zero Core	WES 7E	WIN10 IoT
HP Velocity	√	√	√
HP Easy Shell	N/A	√	√
HP Universal Print Driver	N/A	√	√
Windows Media Player	N/A	12	12
Microsoft Direct Access	N/A	N/A	√
Microsoft BranchCache	N/A	N/A	√
Microsoft AppLocker	N/A	N/A	√
Microsoft Sideloading	N/A	N/A	√

NOTE: Other add-on software available (see: http://www.hp.com/support for latest list of available add-ons). Software performance and support may vary depending on customer environment and backend.

	НР	Microsoft Win	dows Embedded
Audio/Video CODECs	ThinPro Smart Zero Core	WES 7E	WIN 10 IoT
MP3	√	√	√
WMA stereo	√	√	√
AAC stereo & HE AAC	√	N/A	N/A
Microsoft AC3 encoder	N/A	√	√
MPEG-1	√	N/A	N/A
MPEG-4 part 2 (DivX, Xvid, H.263)	√	√	√
MPEG-4 part 10 (H.264, AVC)	√	√	√
WMV 7/8/9/ VC-1 & ASF Demuxer	√	√	√



TEXT AND GRAPHICS TERMINAL EMULATIONS

(provided by HP TeemTalk 7 in HP ThinPro & WES 7 operating systems)

Emulation Terminal ID

HP 700-92/96 70092, 70094, 70096, 2392A, 2622A

IBM3151 Mod11, Mod31

3278-2 (24x80), 3278-3 (32x80), 3278-4 (43x80), 3278-5 (27x132), 3278-2-E (24x80), 3278-

IBM3270 3-E (32x80), 3278-4-E (43x80), 3278-5-E (27x132), 3279-2 (24x80), 3279-3 (32x80), 3279-4

(43x80), 3279-5 (27x132), 3287-1

IBM5250 5291-1, 5292-2, 5251-11, 3179-2, 3196-A1, 3180-2, 3477-FC (27x132), 3477-FG (24x80),

3486-BA, 3487-HA, 3487-HC, 3812-1

VT52, VT100, VT100+, VT500 (7- or VT100, VT101, VT102, VT125, VT131, VT132, M2200, VT220, VT240, VT320, VT340, VT420,

8-bit) VT510, VT520, VT525

VT HP220, VT100, VT101, VT102, VT125, VT220, VT240, VT320, VT340, VT420, VT131, VT132, M2200,

VT UTF8 VT510, VT520, VT525

NOTE: Wireless features, performance and support may vary depending on environmental variables such placement, settings and firmware of your access points. Please contact your wireless vendor for support of your wireless environment

WEIGHTS & DIMENSIONS

WxDxH:

(vertical orientation) With stand: 12 x 22 x 25.1 cm; 4.72 x 8.66 x 9.88 in Without stand: 4.2 x 22 x 24 cm; 1.65 x 8.66 x 9.45 in

Volume: 2.21liters; 74.73 fl oz

System Weight With stand = 1.52kg; 3.35 lb (unit with stand) Without stand = 1.45 kg; 3.20 lb

Shipping Weight 4.1kg; 9.04 lb

NOTE: All measurements are approximate; the addition of optional modules will increase the weight

EXTERNAL POWER SUPPLY

65W external power adapter

Worldwide auto-sensing 100-240 VAC, 50-60 Hz

Energy-saving automatic power-down

Surge-tolerant

External power adapters are sourced from a number of suppliers in order to ensure adequate supply and availability is maintained. The actual dimensions (cm) of the power brick will vary by supplier.

Chicony 12.6(L) x 5.0(W) x 3.0(H) cm

Delta 10.8(L) x 4.6(W) x 2.95(H) cm

LiteOn 11.35(L) x 5.5(W) x 3.0(H) cm



REGULATORY COMPLIANCE

Ergonomics: Approved

Safety: UL 1950, CSA 950; TÜV-GS (EN60 950); approved

RF Interference: FCC Class B; CE Mark; EN55022B; VCCI

ENVIRONMENTAL

Standard

50° to 104° F (10° to 40° C)

Using Quick Release with a flat panel monitor

Operating Temperature Range: 50° to 95° F (10° to 35° C)

t630 with Fiber NIC:

50° to 95° F (10° to 35° C)

Non-operating Temperature

Range:

-22° to 140° F (-30° to 60° C)

Humidity: Condensing: 20% to 80% Non-condensing: 10% to 90%

NOTE: Specifications are at sea level with altitude derating of 1° C/300m (1.8° F/1000ft) to a maximum of 3 Km (10,000 ft), with no direct, sustained sunlight. Upper limit may be limited by the type and number of options installed.

Basic Configuration (does not include a fiber optic NIC):

Energy Consumption: (in accordance with US ENERG	Y STAR® test method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
	Normal Operation: (short idle)	12.4	13.2	12.4
	Normal Operation: (long idle)	10.9	11.5	11.2
	Sleep	1.18	1.24	1.17
	Off	0.2	0.25	0.2
Heat Dissipation		115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
	Normal Operation: (short idle)	42 BTU/hr	45 BTU/hr	42 BTU/hr
	Normal Operation: (long idle)	37 BTU/hr	39 BTU/hr	38 BTU/hr
	Sleep	4 BTU/hr	4 BTU/hr	4 BTU/hr
	Off	0.7 BTU/hr	0.9 BTU/hr	0.7 BTU/hr

System configuration includes: Thin Pro - 64bit, 128 GB primary storage. 32 GB secondary storage, 32 GB of system memory, USB keyboard & USB mouse

Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.



QuickSpecs

Technical Specifications

Optional Configuration (includes a fiber optic NIC):

Energy Consumption: (in accordance with US ENERGY	STAR® test method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
	Normal Operation: (short idle)	10.5	13.2	12.4
	Normal Operation: (long idle)	10.9	11.5	11.2
	Sleep	1.18	1.24	1.17
	Off	0.2	0.25	0.2
Heat Dissipation		115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
	Normal Operation: (short idle)	36 BTU/hr	45 BTU/hr	42 BTU/hr
	Normal Operation: (long idle)	37 BTU/hr	39 BTU/hr	38 BTU/hr
	Sleep	4 BTU/hr	4 BTU/hr	4 BTU/hr
	Off	0.7 BTU/hr	0.9 BTU/hr	0.7 BTU/hr

System configuration includes: WES 7E-32bit, 100 Mbps SC Fiber NIC, 128 GB primary storage. 32 GB secondary storage, 32 GB of system memory, USB keyboard & USB mouse

Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.



Summary of Changes

Date of change:	Version History:	Type of change	Description of change:
	From v1 to v2		



© 2016 HP Development Company, L.P. The information contained herein is subject to change without notice. The only warranties for HP products and services are set forth in the express limited warranty statements accompanying such products and services. Nothing herein should be construed as constituting an additional warranty. HP shall not be liable for technical or editorial errors or omissions contained herein. DisplayPort™ and the DisplayPort™ logo are trademarks owned by the Video Electronics Standards Association (VESA®) in the United States and other countries. Microsoft and Windows are either registered trademarks or trademarks of Microsoft Corporation in the United States and/or other countries. Intel and the Intel Inside logo are trademarks of Intel Corporation in the U.S. and other countries. ENERGY STAR is a registered mark owned by the U.S. government. Linux® is the registered trademark of Linus Torvalds in the U.S. and other countries. AMD and Radeon are trademarks of Advanced Micro Devices, Inc. Bluetooth is a trademark owned by its proprietor and used by HP Inc. under license. Citrix and XenDesktop are trademarks of Citrix Systems, Inc. and/or one more of its subsidiaries, and may be registered in the United States Patent and Trademark Office and in other countries. VMware is a registered trademark or trademark of VMware, Inc. in the United States and/or other jurisdictions.

